

Reliability Test Report

Product Name: PB-03M

Product Model: Bluetooth Series

Test Date: 2021/12/06–2021/12/10

Tested by: Han Zhiying

Reviewed by: Zhou Yuming




1. Inspection Plan

No.	Process Name	Inspection Item	Inspection Equipment	Sampling Level (Refer to GB/T 2828.1-2003)	Acceptable Quality Level		
					CR (Critical Defect)	MA (Major Defect)	MI (Minor Defect)
1	Reliability test	High/low temperature storage; high/room/low temperature power on/off; high/low temperature operation; alternating hot and humid; thermal shock	Constant temperature and humidity chamber	Normal single sampling, special inspection S-1	0 accept, 1 reject		

2. Test Items

No.	Item	Test Conditions
1	Low temperature storage test	Test conditions: -40°C Test duration: 8h After an 8-hour soak at -40°C, perform a cold start test.
2	High temperature storage test	Test conditions: 100°C Test duration: 8h After restoring to 85°C and a 1-hour soak, perform a hot start test.
3	Low temperature operation test	Test conditions: -40°C Test duration: 24h
4	High temperature operation test	Test conditions: 85°C Test duration: 24h
5	AC power on/off test with temperature	A) Temperature: -40°C B) Temperature: 25°C C) Temperature: 85°C Cycle each condition 200 times, with 30s ON and 30s OFF
6	Alternating hot and humid test	A) Operate at 85°C + 93% RH for 4h; B) Operate at 25°C + 93% RH for 4h; Cycle steps A and B for a total of 2 cycles.
7	Thermal shock test	Test conditions: -40°C–100°C, soak for 30min at each temperature. Temperature transition time: 50min for heating, 2h for cooling. Test duration: 5 cycles

3. Test Preparation

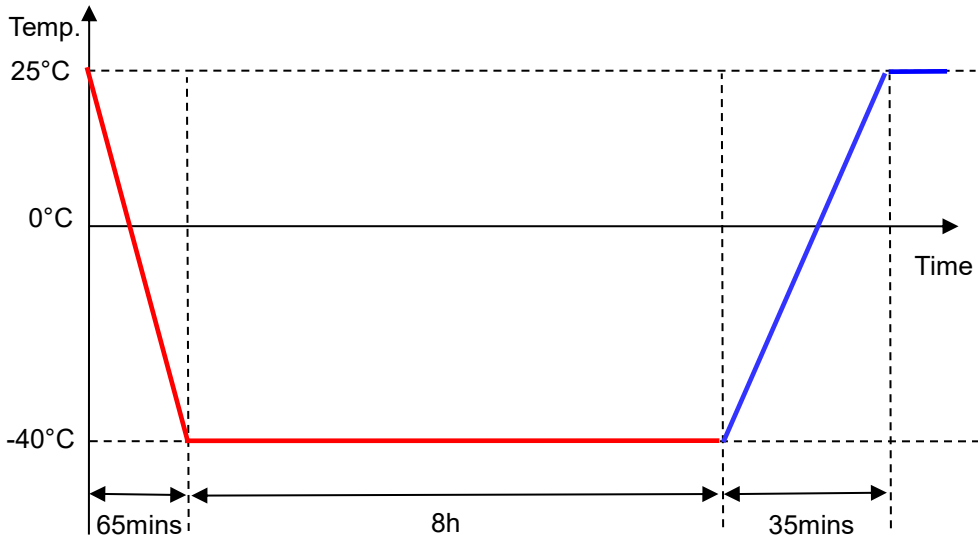
No.	Item	Image/Attachment
1	Reliability documentation	 PB-03系列模组可靠性测试说明.doc
2	Test equipment	
3	Sample placement	
4	Test reason	Reliability verification for PB-03M module

4. Low Temperature Storage Test

Test Conditions: Power-off test. Store the product at -40°C for 8h, then perform a cold start test.

Test Profile:

Is Power Off ——
 Is Power On ——



Test Criteria:

1. If the module functions normally during the cold start test, and can successfully pair with the mobile device, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

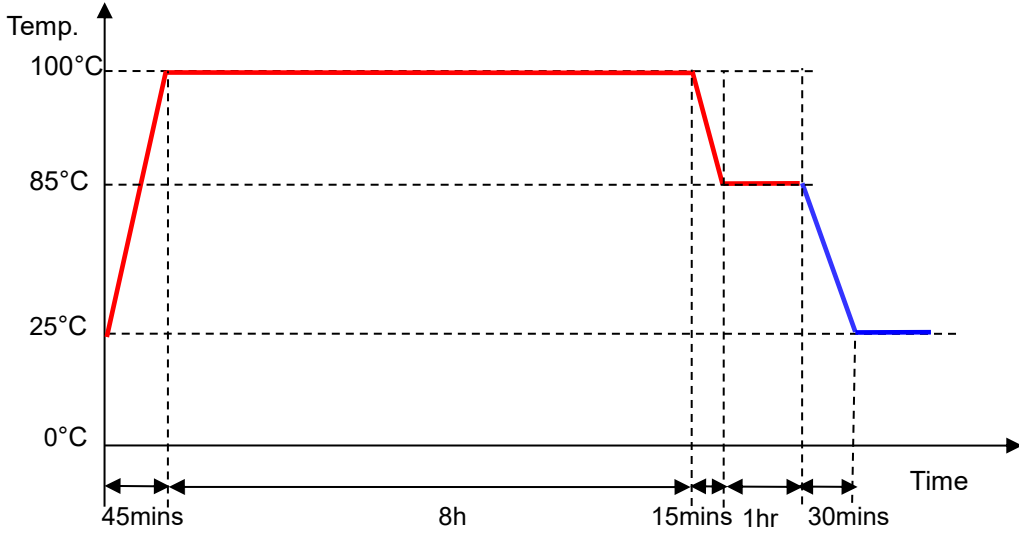
Sample Quantity	Test Data	Test Results
Unit 1 Unit 2		PASS

5. High Temperature Storage Test

Test Conditions: Power-off test. Store the product at 100°C for 8h, then restore it to 85°C for a 1-hour soak, and perform a hot start test.

Test Profile:

Is Power Off ——
Is Power On ——



Test Criteria:

1. If the module functions normally during the hot start test, and can successfully pair with the mobile device, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

Sample Quantity	Test Data	Test Results
Unit 1 Unit 2		PASS

Scanner		Bonded
	09:0C:EF:70:6F:96 NOT BONDED	-90 dBm
	ai-thinker 94:C9:60:1D:0B:55 NOT BONDED	-52 dBm CONNECT ⋮
	N/A 5D:01:03:9D:58:4C NOT BONDED	-98 dBm
	ai-thinker 94:C9:60:1D:0B:5A NOT BONDED	-62 dBm CONNECT ⋮
	N/A 4F:A4:D2:39:DA:94 NOT BONDED	-96 dBm
	N/A 20:93:29:D8:36:3C NOT BONDED	-91 dBm
	N/A 6B:E2:BC:70:71:88 NOT BONDED	-85 dBm CONNECT ⋮

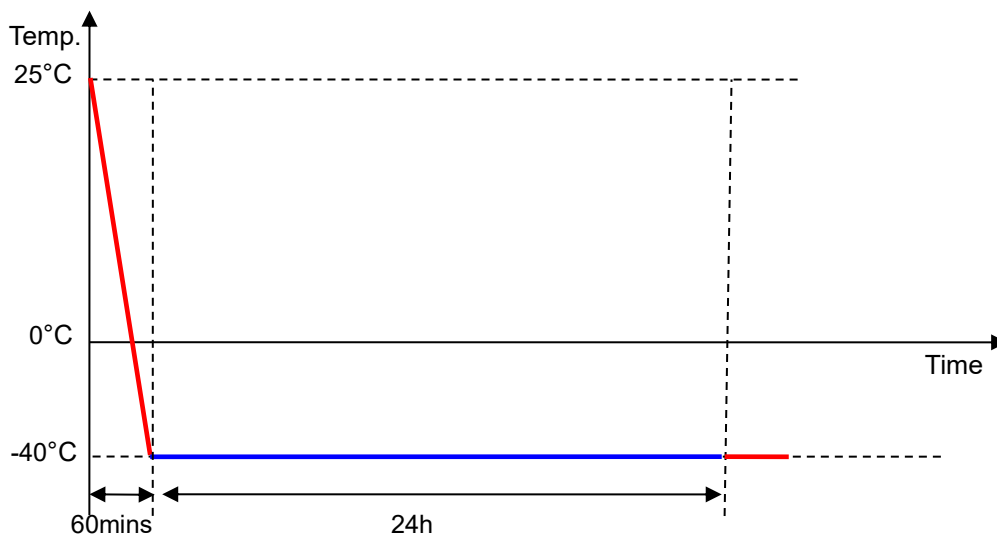
6. Low Temperature Operation Test

Test Conditions: Power-on test. Operate at -40°C for 24h.

Test Profile:

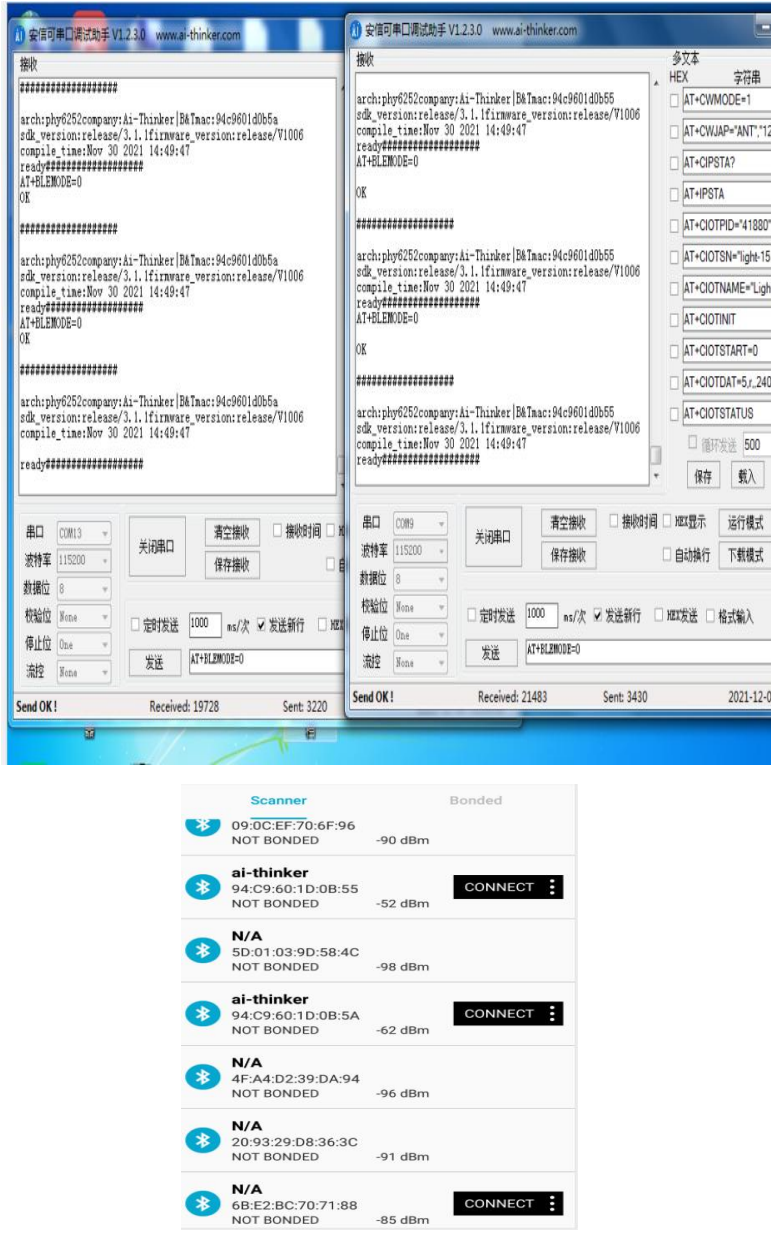
Is Power Off ———

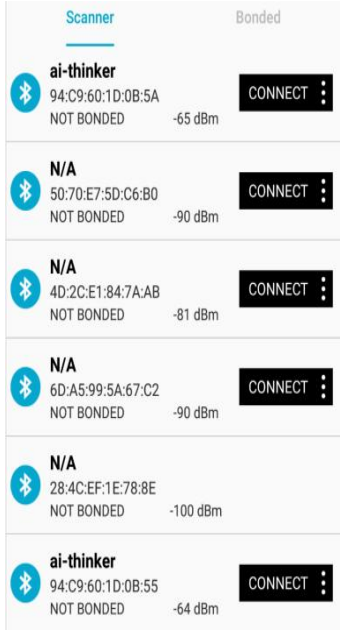
Is Power On ———



Test Criteria:

1. If no reboot or crash occurs during testing and it can pair with the mobile device properly, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

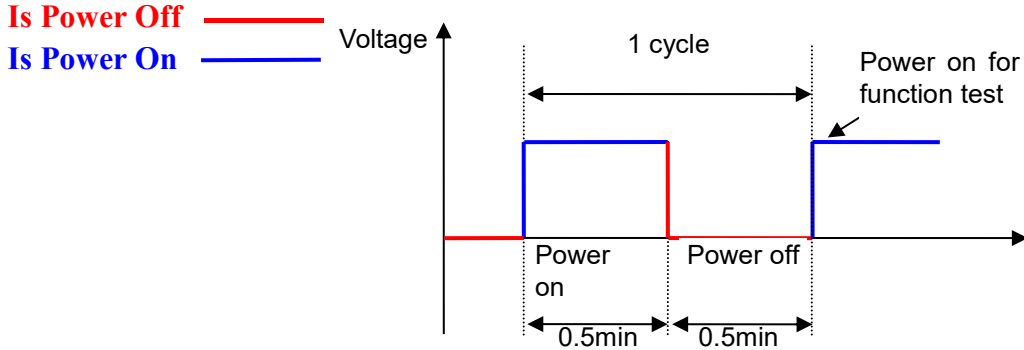
Sample Quantity	Test Data	Test Results
<p>Unit 1 Unit 2</p>		<p>PASS</p>

	 <p>Scanner Bonded</p> <ul style="list-style-type: none">ai-thinker 94:C9:60:1D:0B:5A NOT BONDED -65 dBm CONNECTN/A 50:70:E7:5D:C6:B0 NOT BONDED -90 dBm CONNECTN/A 4D:2C:E1:84:7A:AB NOT BONDED -81 dBm CONNECTN/A 6D:A5:99:5A:67:C2 NOT BONDED -90 dBm CONNECTN/A 28:4C:EF:1E:78:8E NOT BONDED -100 dBmai-thinker 94:C9:60:1D:0B:55 NOT BONDED -64 dBm CONNECT	
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8. AC Power On/Off Test with Temperature

- Test Conditions:**
1. Power on: 30s; power off: 30s.
 2. Temperature: -40°C, 25°C, 85°C.
 3. Cycle: Each test condition cycles 200 times.

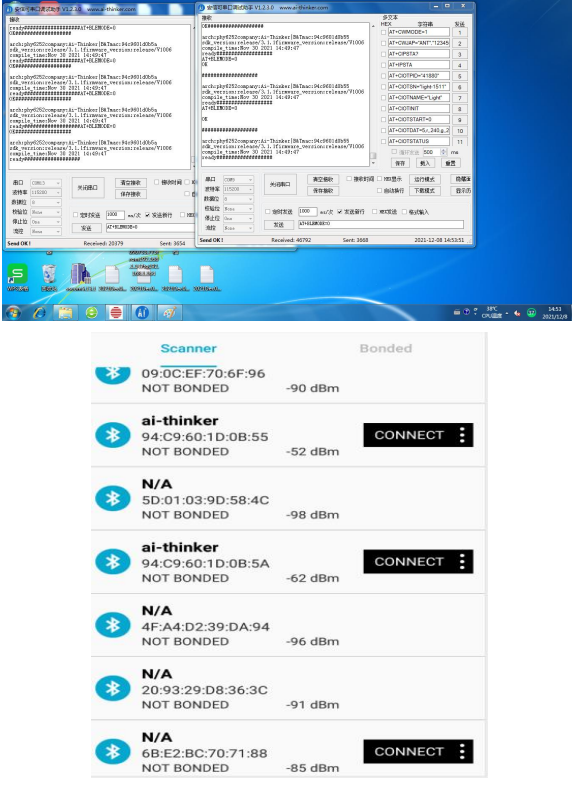
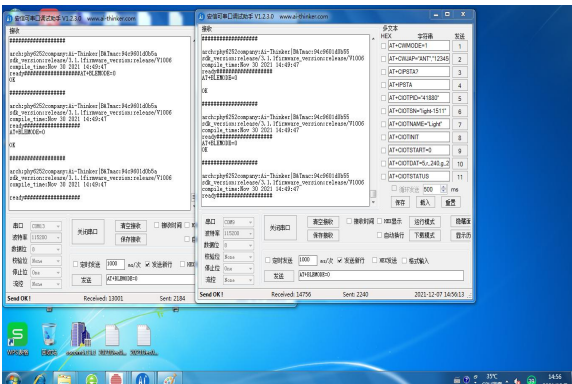
Test Profile:



Test Criteria:

1. After power-up, if the module can pair with the mobile device properly, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

Item	Sample Quantity	Test Data	Test Results
Power on/off at room temperature	Unit 1 Unit 2		PASS

<p>Power on/off at low temperature</p>	<p>Unit 1 Unit 2</p>	 <p>Scanner</p> <table border="1"> <thead> <tr> <th>Device</th> <th>MAC Address</th> <th>Signal Strength</th> <th>Status</th> </tr> </thead> <tbody> <tr> <td>09:0C:EF:70:6F:96</td> <td>09:0C:EF:70:6F:96</td> <td>-90 dBm</td> <td>NOT BONDED</td> </tr> <tr> <td>ai-thinker</td> <td>94:C9:60:1D:0B:55</td> <td>-52 dBm</td> <td>CONNECT</td> </tr> <tr> <td>N/A</td> <td>5D:01:03:9D:58:4C</td> <td>-98 dBm</td> <td>NOT BONDED</td> </tr> <tr> <td>ai-thinker</td> <td>94:C9:60:1D:0B:5A</td> <td>-62 dBm</td> <td>CONNECT</td> </tr> <tr> <td>N/A</td> <td>4F:A4:D2:39:DA:94</td> <td>-96 dBm</td> <td>NOT BONDED</td> </tr> <tr> <td>N/A</td> <td>20:93:29:D8:36:3C</td> <td>-91 dBm</td> <td>NOT BONDED</td> </tr> <tr> <td>N/A</td> <td>6B:E2:BC:70:71:88</td> <td>-85 dBm</td> <td>CONNECT</td> </tr> </tbody> </table>	Device	MAC Address	Signal Strength	Status	09:0C:EF:70:6F:96	09:0C:EF:70:6F:96	-90 dBm	NOT BONDED	ai-thinker	94:C9:60:1D:0B:55	-52 dBm	CONNECT	N/A	5D:01:03:9D:58:4C	-98 dBm	NOT BONDED	ai-thinker	94:C9:60:1D:0B:5A	-62 dBm	CONNECT	N/A	4F:A4:D2:39:DA:94	-96 dBm	NOT BONDED	N/A	20:93:29:D8:36:3C	-91 dBm	NOT BONDED	N/A	6B:E2:BC:70:71:88	-85 dBm	CONNECT	<p>PASS</p>
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9. Alternating Hot and Humid Test

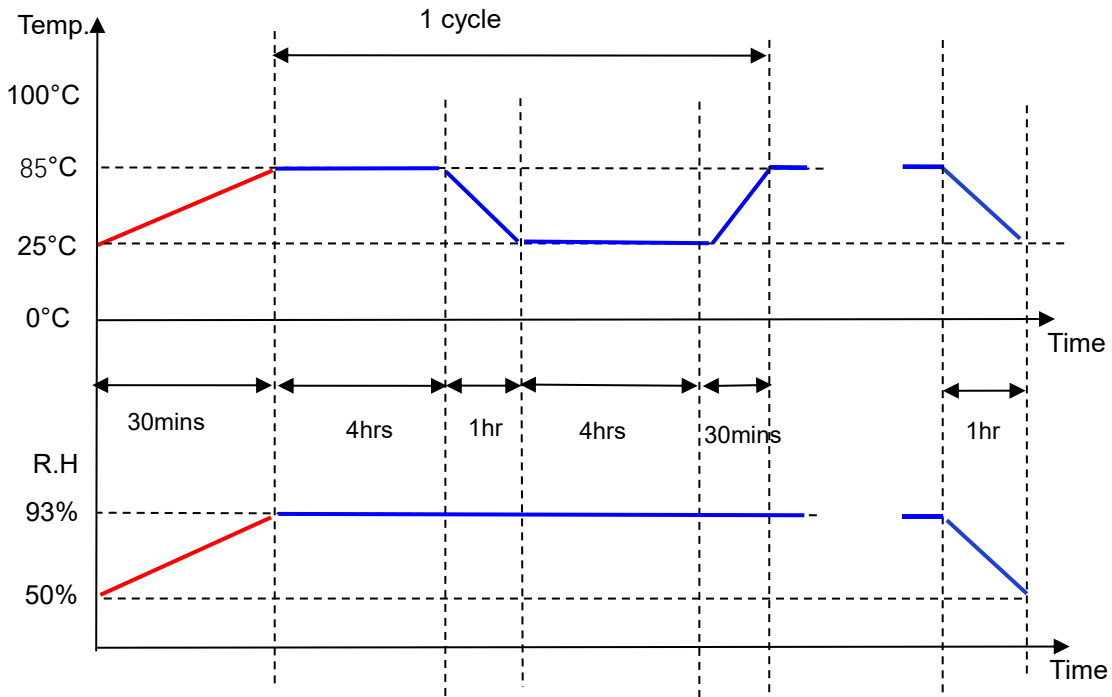
Test Conditions:

1. Operate at 85°C + 93% RH for 4h;
 2. Operate at 25°C + 93% RH for 4h;
- Cycle step 1 and step 2, a total of 2 cycles.

Test Profile:

Is Power Off —

Is Power On —



Test Criteria:

1. After power-up, if the module can pair with the mobile device properly, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

Sample Quantity	Test Data	Test Results
<p>Unit 1</p> <p>Unit 2</p>		<p>PASS</p>

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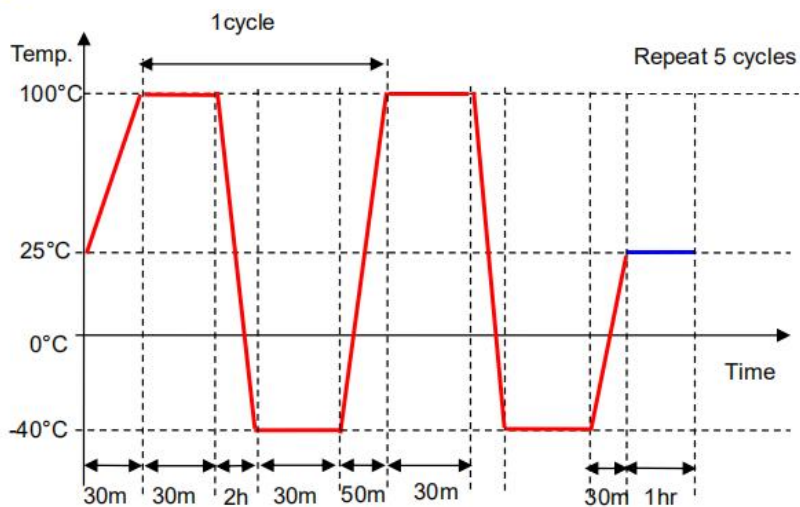
10. Thermal Shock Test

Test Conditions:

Power-off test. Temperature cycling between -40–100°C, with a heating time of 50min and a cooling time of 2h. Each stage is held for 30min, for a total of 5 cycles.

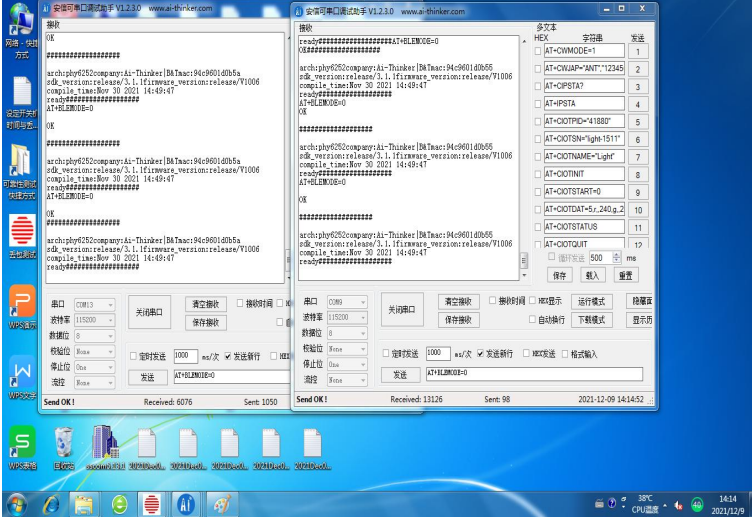
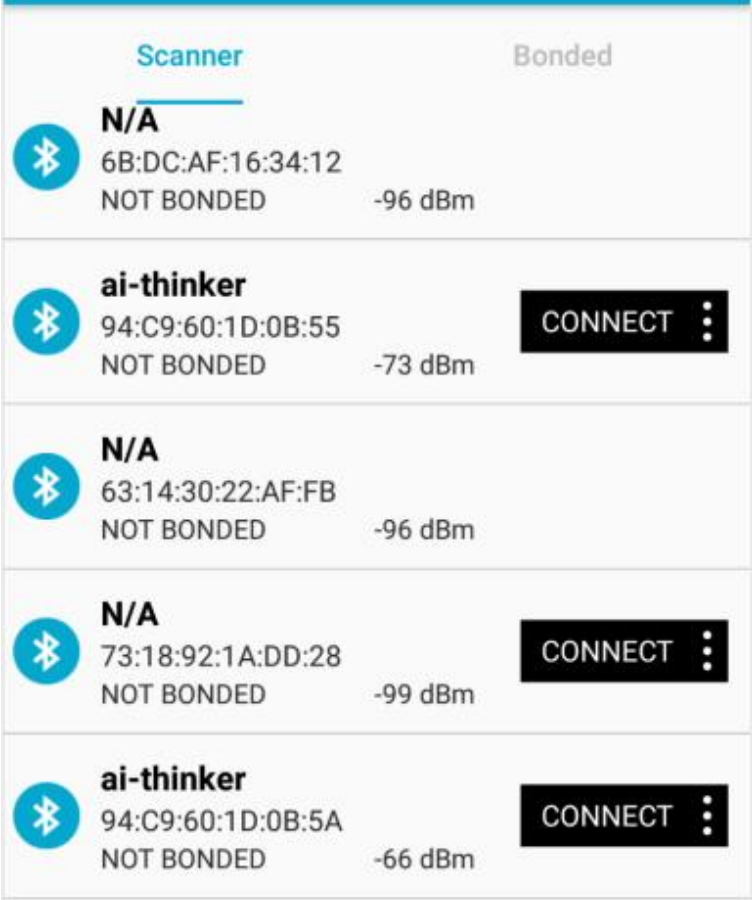
Test Profile:

— Is Power Off
— Is Power On



Test Criteria:

1. After power-up, the module boots normally. If ping packets are confirmed not to be lost, the module is considered to be functional.
2. After the test, the product shows no visible damage such as shrinkage, peeling, or discoloration.

Sample Quantity	Test Data	Test Results
<p>Unit 1</p> <p>Unit 2</p>	 	<p>PASS</p>